

ON Semiconductor®

# FDC642P

# Single P-Channel 2.5V Specified PowerTrench® MOSFET -20 V, -4.0 A, 65 m $\Omega$

#### **Features**

- Max  $r_{DS(on)}$  = 65 m $\Omega$  at  $V_{GS}$  = -4.5 V,  $I_D$  = -4.0 A
- Max  $r_{DS(on)}$  = 100 m $\Omega$  at  $V_{GS}$  = -2.5 V,  $I_D$  = -3.2 A
- Fast switching speed
- Low gate charge (11nC typical)
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- SuperSOT<sup>TM</sup>-6 package: small footprint (72% smaller than standard SO-8); low profile (1 mm thick)
- Termination is Lead-free and RoHS Compliant



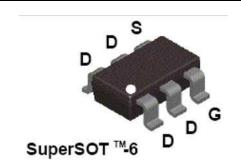
## **General Description**

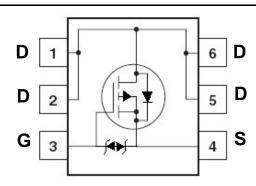
This P-Channel 2.5V specified MOSFET is produced using ON Semicondcutor's advanced PowerTrench® process that has been especially tailored to minimize on-state resistance and yet maintain low gate charge for superior switching performance.

These devices have been designed to offer exceptional power dissipation in a very small footprint for applications where the larger packages are impractical.

# **Applications**

- Load switch
- Battery protection
- Power management





# **MOSFET Maximum Ratings** $T_C = 25$ °C unless otherwise noted

Symbol	Param	eter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage			-20	V
V <sub>GS</sub>	Gate to Source Voltage			±8	V
	-Continuous	T <sub>A</sub> = 25°C	(Note 1a)	-4.0	Λ.
ID	-Pulsed			-20	Α
D	Power Dissipation		( Note 1a)	1.6	W
$P_{D}$	Power Dissipation		(Note 1b)	0.8	vv
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Tempera	ature Range		-55 to + 150	°C

### **Thermal Characteristics**

$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	78	°C/W

# **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.642	FDC642P	SSOT-6 <sup>TM</sup>	7 "	8 mm	3000 units

# **Electrical Characteristics** T<sub>J</sub> = 25°C unless otherwise noted

Symbol	Parameter Test Conditions		Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	<b>I</b> <sub>D</sub> = -250 μA, V <sub>GS</sub> = 0 V	-20			V
$\frac{\Delta BV_{DS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = -250 μA, referenced to 25°C		-13		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -16 V, V <sub>GS</sub> = 0 V			-1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μΑ

#### **On Characteristics**

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-0.4	-0.6	-1.5	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = -250 $\mu$ A, referenced to 25°C		2.5		mV/°C	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -4.0 A		45	65		
		V <sub>GS</sub> = -2.5 V, I <sub>D</sub> = -3.2 A		55	100	mΩ	
		$V_{GS}$ = -4.5 V, $I_{D}$ = -4.0 A, $T_{J}$ = 125°C		62	90	11122	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = -5 V, I <sub>D</sub> = -4.0 A		15		S	

# **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V - 40 V V - 0 V	700	925	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	110	150	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1 101112	95	145	pF

## **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		6	12	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = -10 V, I <sub>D</sub> = -1 A,	7	14	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = -4.5 V, $R_{GEN}$ = 6 $\Omega$	120	190	ns
t <sub>f</sub>	Fall Time		52	83	ns
$Q_g$	Total Gate Charge	V = 40 V I = 4 A	11	16	nC
$Q_{gs}$	Gate to Source Charge	$V_{DD} = -10 \text{ V, } I_{D} = -4 \text{ A}$ $V_{GS} =4.5 \text{ V}$	1.1		nC
$Q_{gd}$	Gate to Drain "Miller" Charge	VGS	3.0		nC

## **Drain-Source Diode Characteristics**

Is	Maximum Continuous Drain-Source Diode Forward Current				-1.3	Α
$V_{SD}$	Source-Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = -1.3 \text{ A}$	(Note 2)	-0.7	-1.2	V

#### Notes

- 1: R<sub>0,IA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0,IC</sub> is guaranteed by design while R<sub>0,CA</sub> is determined by the user's board design.
  - a. 78 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.
  - b. 156°C/W when mounted on a minimum pad of 2 oz copper.
- 2: Pulse Test: Pulse Width<300 us, Duty Cycle<2.0%.

# Typical Characteristics T<sub>J</sub> = 25°C unless otherwise noted

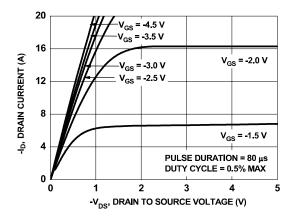


Figure 1. On Region Characteristics

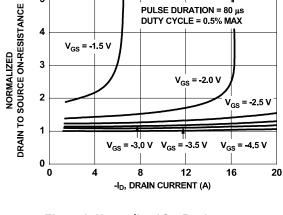


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

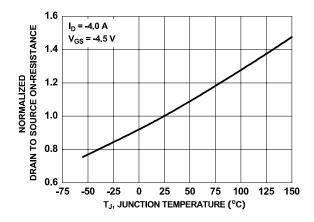


Figure 3. Normalized On Resistance vs Junction Temperature

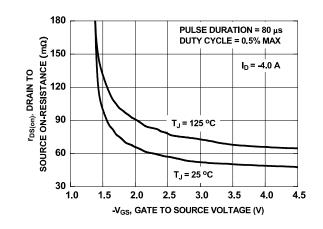


Figure 4. On-Resistance vs Gate to Source Voltage

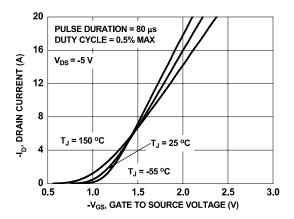


Figure 5. Transfer Characteristics

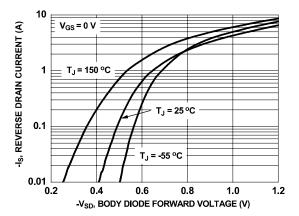


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

# Typical Characteristics T<sub>J</sub> = 25°C unless otherwise noted

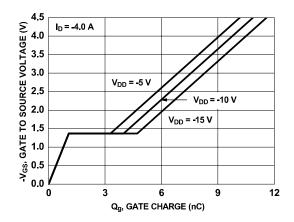


Figure 7. Gate Charge Characteristics

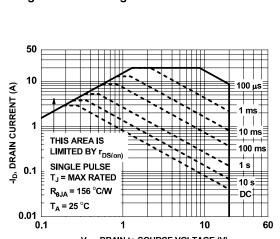


Figure 9. Forward Bias Safe **Operating Area** 

-V<sub>DS</sub>, DRAIN to SOURCE VOLTAGE (V)

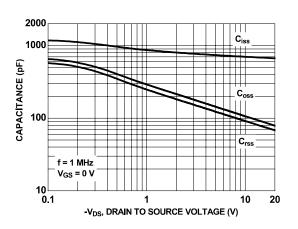


Figure 8. Capacitance vs Drain to Source Voltage

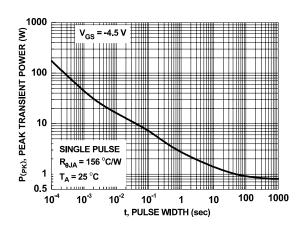


Figure 10. Single Pulse Maximum **Power Dissipation** 

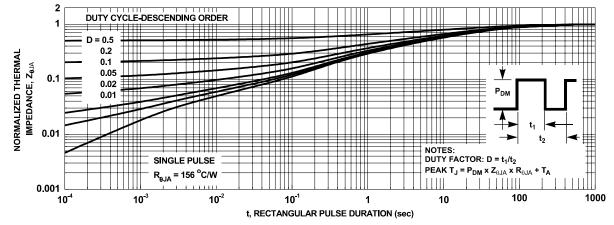


Figure 11. Junction-to-Ambient Transient Thermal Response Curve

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